Building Blocks of Power



Tim Goodrow

On July 4, 1795, Paul Revere and Sam Adams set a cornerstone in the Massachusetts state house. Inside the cornerstone was a time capsule containing newspapers, coins and American emblems- early building blocks of America. On Jan. 6, 2015, the time capsule was opened. Its contents were displayed at a public museum in Boston and then later placed back into the cornerstone.

Products like an Ethernet switch are also made up of building blocks. The processor, ASIC or FPGA controller is usually central to the topology and can be likened to that cornerstone, acting as a foundation. Around the controller, however, are a myriad of power chips that work together to provide processing power and support the activity of system loads.

TI is committed to providing full system solutions for power and has developed deep product offerings supporting our customers' designs. Some of the key functions beyond the controller are:

- Linear regulators.
- Hot-swap controllers.
- Voltage sequencers.
- Current-shunt monitors.
- PowerMOSFETs.
- Double data rate (DDR) memory termination.
- Voltage references.
- Graphical user interface.
- MOSFET drivers.
- DC/DC regulators.

The TI Designs Complete PMBus Power System for Enterprise Ethernet Switches Reference Design is a power reference design on display at the 2016 Applied Power Electronics Conference (APEC) that will showcase a complete power system for an Ethernet switch. It is a PMBus power system for three ASIC/FPGA cores, DDR3 core memory, VTT termination and auxiliary voltages commonly found on high-performance Ethernet switches. A GUI that allows real-time power-supply configuration and monitoring accompanies the hardware.

The UCD90240 can sequence eight voltage rails to support any of the startup requirements of the ASICs or FPGAs. The order of this sequence can be easily modified in development and then set for proper operation in production. Figure 1 shows the voltage rails startup sequence for the design.

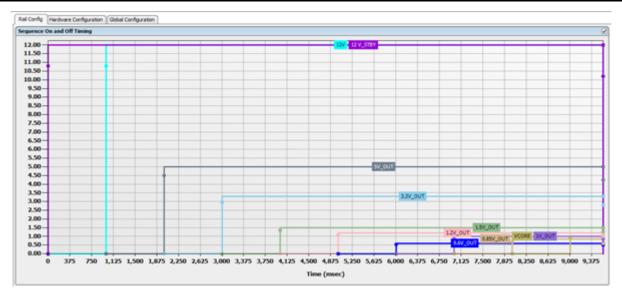


Figure 1. Voltage-sequencing Pattern

The reference design includes a power reference board capable of sourcing 300W and measuring power usage on any of the output rails. The INA194 current-shunt monitor provides a high-accuracy, temperature-stable measurement for the power system.

This information can be reported back via the PMBus interface by the system controller to provide real-time power-usage effectiveness of the system. Figure 2 shows the GUI dashboard displaying power output of individual output rails.

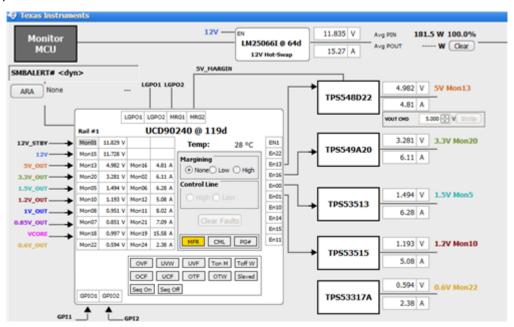


Figure 2. PMBus Power System for Enterprise Ethernet Switches Reference Design: GUI Dashboard

In addition to providing protection and power monitoring, the LM25066 hot-swap and protection IC has a compliant PMBus command structure enabling system margining. The ability to margin the voltage rails is critical for robust system characterization. Figure 3 shows the active monitoring of power and temperature of the power stages delivering power to ASIC2 and ASIC3.

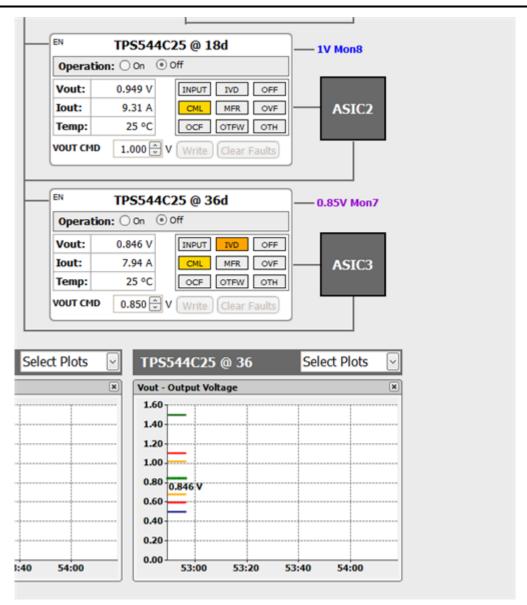


Figure 3. Power and Temperature Monitoring

See our "Building Blocks of Power" demonstration in TI's booth (No. 1617) at the Applied Power Electronics Conference (APEC), March 21-23 in Long Beach, California. Follow TI at www.ti.com/apec2016. Attend the "Next Gen PMBus Point-of-Load Solution" presentation, presented by TI in the Wurth booth (No. 1933) on Wednesday, March 23 at 1p.m.

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